

SBOS096A - JANUARY 1998 - REVISED MAY 2007

MULTI-CLOCK GENERATOR

FEATURES

● 27MHz MASTER CLOCK INPUT

• GENERATED AUDIO SYSTEM CLOCK:

SCKO1: 33.8688MHz (Fixed)

SCKO2: 256f_S SCKO3: 384f_S SCKO4: 768f_S

ZERO PPM ERROR OUTPUT CLOCKS

■ LOW CLOCK JITTER: 150ps at SCKO3

MULTIPLE SAMPLING FREQUENCIES:
 f_S = 32kHz, 44.1kHz, 48kHz, 64kHz,

88.2kHz, 96kHz

◆ +3.3V CMOS LOGIC INTERFACE

DUAL POWER SUPPLIES: +5V and +3.3V

SMALL PACKAGE: 20-Lead SSOP

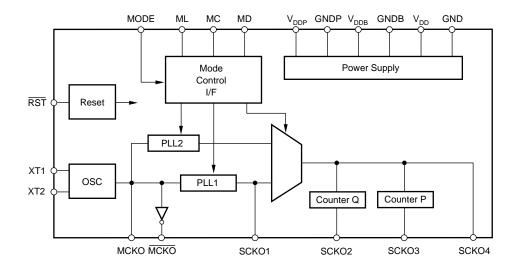
DESCRIPTION

The PLL1700 is a low cost, multi-clock generator Phase Lock Loop (PLL).

The PLL1700 can generate four systems clocks from a 27MHz reference input frequency.

The device gives customers both cost and space savings by eliminating external components and enables customers to achieve the very low jitter performance needed for high-performance audio digital-to-analog converters (DACs) and/or analog-to-digital converters (ADCs).

The PLL1700 is ideal for MPEG-2 applications that use a 27MHz master clock such as DVD players, DVD add-on cards for multimedia PCs, digital HDTV systems, and settop boxes.





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ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ABSOLUTE MAXIMUM RATINGS(1)

Supply Voltage (+V _{DD} , +V _{DDP} , +V _{DDB}) Supply Voltage Differences (+V _{DD} , +V _{DDP})	
GND Voltage Differences: GND, GNDP, GNDB	
Digital Input Voltage	
Digital Output Voltage	0.3V to (V _{DDB} + 0.3V)
Input Current (any pins except supply pins)	±10mA
Power Dissipation	300mW
Operating Temperature Range	–25°C to +85°C
Storage Temperature	–55°C to +125°C
Lead Temperature (soldering, 5s)	+260°C
Package Temperature (IR reflow, 10s)	+235°C

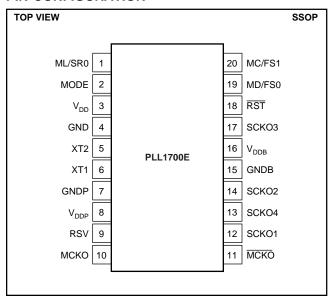
NOTE: (1) Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.

PACKAGE INFORMATION(1)

PRODUCT	PACKAGE	SPECIFIED TEMPERATURE RANGE	PACKAGE DESIGNATOR
PLL1700E	20-Lead SSOP	–25°C to +85°C	DB

NOTE: (1) For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or see the TI web site at www.ti.com.

PIN CONFIGURATION



PIN ASSIGNMENTS

PIN	NAME	I/O	FUNCTION
1	ML/SR0	IN	Latch Enable for Software Mode/Sampling Rate Selection for Hardware Mode. When MODE pin is LOW, ML is selected. ⁽¹⁾
2	MODE	IN	Mode Control Select. When this pin is HIGH, device is operated in hardware mode using SR0 (pin 1), FS0 (pin 19), and FS1 (pin 20). When this pin is LOW, device is operated in software mode by three-wire interface using ML (pin 1), MD (pin 19) and MC (pin 20). ⁽¹⁾
3	V _{DD}	_	Digital Power Supply, +5V.
4	GND	_	Digital Ground.
5	XT2	_	27MHz Crystal. When an external 27MHz clock is applied to XT1 (pin 6), this pin must be connected to GND.
6	XT1	IN	27MHz Oscillator Input/External 27MHz Input.
7	GNDP	_	Ground for PLL.
8	V _{DDP}	_	Power Supply for PLL, +5V.
9	RSV	_	Reserved. Must be left open.
10	мско	OUT	27MHz Output.
11	MCKO	OUT	Inverted 27MHz Output.
12	SCKO1	OUT	Fixed 33.8688MHz Clock Output.
13	SCKO4	OUT	768f _S Clock Output.
14	SCKO2	OUT	256f _S Clock Output.
15	GNDB	_	Digital Ground for V _{DDB} .
16	V _{DDB}	_	Digital Power Supply for Clock Output Buffers, +3.3V.
17	SCKO3	OUT	$384f_{\rm S}$ Output. This output has been optimized for the lowest jitter and should be connected to the audio DAC(s).
18	RST	IN	Reset. When this pin is LOW, device is held in reset. ⁽¹⁾
19	MD/FS0	IN	Serial Data Input for Software Mode/Sampling Frequency Selection for Hardware Mode. When MODE pin is LOW, MD is selected. ⁽¹⁾
20	MC/FS1	IN	Shift Clock Input for Software Mode/Sampling Frequency Selection for Hardware Mode. When MODE pin is LOW, MC is selected. ⁽¹⁾

NOTE: (1) Schmitt-trigger input with internal pull-down resistors.



ELECTRICAL CHARACTERISTICS

All specifications at $T_A = +25^{\circ}C$, $V_{DD} = V_{DDP} = +5V$, $V_{DDB} = +3.3V$, $f_M = 27MHz$ crystal oscillation, and $f_S = 48kHz$, unless otherwise noted.

			PLL1700E			
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
DIGITAL INPUT/OUTPUT						
Input Logic Level:		-	TTL-Compatible	•		
V _{IH} ⁽¹⁾		2.0			VDC	
V _{IL} ⁽¹⁾				0.8	VDC	
$V_{H}^{(2)}$		1.2			VDC	
V _{IL} (2)				0.4	VDC	
Input Logic Current:						
I _{IH} ⁽¹⁾	$V_{IN} = V_{DD}$			200	μΑ	
I _{IL} (1)	$V_{IN} = 0V$			-1	μΑ	
I _{IH} ⁽²⁾	$V_{IN} = V_{DD}$			4	mA	
I _{IL} (2)	$V_{IN} = 0V$			-800	μΑ	
Output Logic Level:	"·		CMOS			
V _{OH} ⁽³⁾	$I_{OH} = 4mA$	$V_{DDB} - 0.4V$			VDC	
V _{OL} ⁽³⁾	$I_{OL} = 4mA$	000		0.4	VDC	
Sampling Frequency (f _S)	Standard f _S	32	44.1	48	kHz	
1 0 1 7 (0)	Double f _S	64	88.2	96	kHz	
MASTER CLOCK (MCKO, MCKO)	$f_M = 27MHz, C_L = 20pF$					
Master Clock Frequency	I _M = 27101112, O _L = 20p1	26.73	27	27.27	MHz	
Clock Jitter ⁽⁴⁾		20.70	300	21.21	ps	
Clock Duty Cycle MCKO	$C_1 = C_2 = 15pF$	40	50	60	рз %	
For Crystal Oscillation MCKO	$G_1 = G_2 = 15pi$	40	50 50	60	% %	
Clock Duty Cycle MCKO		40	40	60	% %	
For External Clock MCKO			60		% %	
			60		76	
PHASE LOCK LOOP (PLL)	$f_M = 27MHz, C_L = 20pF$					
Generated System Clock Frequency						
SCKO1	Fixed		33.8688		MHz	
SCKO2	256f _S	8.192		24.576	MHz	
SCKO3	384f _S	12.288		36.864	MHz	
SCKO4	768f _S	24.576		36.864	MHz	
Generated Clock Rise Time ⁽³⁾	20% to 80% V _{DDB}		5		ns	
Generated Clock Fall Time ⁽³⁾	80% to 20% V _{DDB}		5		ns	
Generated Clock Duty Cycle	SCKO1, SCKO3, SCKO4	40	50	60	%	
	SCKO2 (standard)	40	50	60	%	
	SCKO2 (double) ⁽⁵⁾	25	33	40	%	
Generated Clock Jitter ⁽⁴⁾	SCKO1, SCKO2 (standard), SCKO4		300		ps	
	SCKO3		150		ps	
	SCKO2 (double)		450		ps	
Settling Time	To Programmed Frequency			20	ms	
Power-Up Time	To Programmed Frequency		15	30	ms	
POWER SUPPLY REQUIREMENTS						
Voltage Range	V_{DD}, V_{DDP}	+4.5	+5	+5.5	VDC	
	V_{DDB}	+2.7	+3.3	+3.6	VDC	
Supply Current ⁽⁶⁾ :						
$I_{DD} + I_{DDP}$	$V_{DD} = V_{DDP} = 5V$, $f_{S} = 48kHz$		11	16	mA	
I _{DDB}	$V_{DDB} = +3.3V$, $f_{S} = 48kHz$		6	9	mA	
Power Dissipation	$f_S = 48kHz$		75	110	mW	
TEMPERATURE RANGE						
Operation		-25		+85	°C	
Storage		- 55		+125	°C	

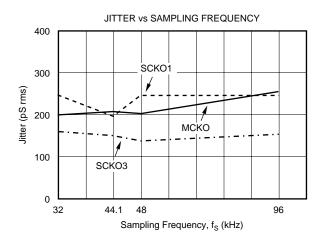
NOTES: (1) ML, MC, MD, MODE, $\overline{\text{RST}}$ (Schmitt-trigger input with internal pull-down resistor).

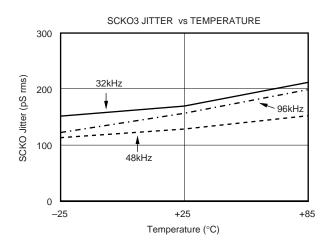
- (2) XT1, when an external 27MHz clock is used, the buffer ICs, such as 74HC04, are recommended to interface to XT1.
- (3) MCKO, MCKO, SCKO4, SCKO3, SCKO2, and SCKO1.
- (4) Jitter performance is specified as standard deviation of jitter under 27MHz crystal oscillation.
- (5) When SCKO2 is set to double rate clock output, its duty cycle is 33%.
- (6) $f_M = 27MHz$ crystal oscillation, no load on MCKO, \overline{MCKO} , SCKO4, SCKO3, SCKO2, and SCKO1.

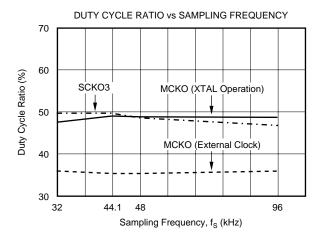


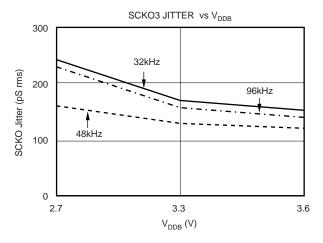
TYPICAL CHARACTERISTICS

At T_A = +25°C, V_{DD} = V_{DDP} = +5V, V_{DDB} = +3.3V, C_L = 20pF, unless otherwise noted.











THEORY OF OPERATION

MASTER CLOCK AND SYSTEM CLOCK OUTPUT

The PLL1700 consists of a dual PLL clock and master clock generator which generates four system clocks and two buffered 27MHz clocks from a 27MHz master clock. Figure 1 shows the block diagram of the PLL1700. The PLL is designed to accept a 27MHz master clock or crystal oscillator. The master clock can be either a crystal

oscillator placed between XT1 (pin 6) and XT2 (pin 5), or an external input to XT1. If an external master clock is used, XT2 must be connected to ground. In both cases, the signal amplitude on XT1 must satisfy the specification described in Figure 3. Therefore, careful $\rm C_1$ and $\rm C_2$ determination is required for keeping this specification when using a crystal oscillator.

Figure 2 illustrates possible system clock connection options. Figure 3 illustrates the 27MHz master clock timing requirements.

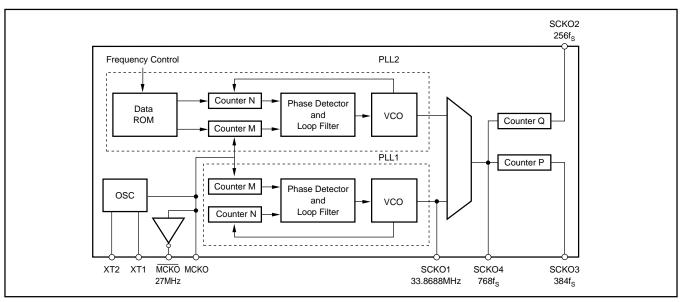


FIGURE 1. Block Diagram of PLL1700.

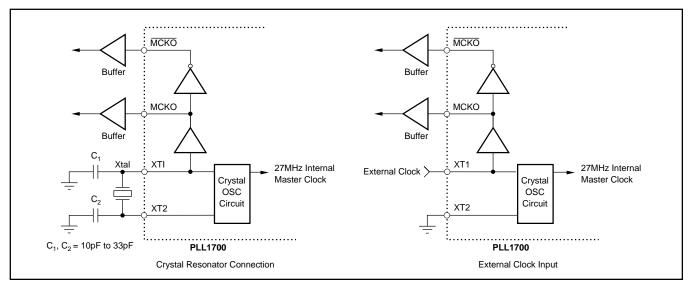


FIGURE 2. Master Clock Generator Connection Diagram.

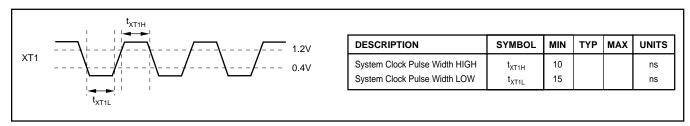


FIGURE 3. External Master Clock Timing Requirement.





The PLL1700 provides a very low jitter, high accuracy clock. SCKO1 is a fixed frequency clock which is 33.8688MHz (768 x 44.1kHz) for a CD-DA DSP. The output frequency of the remaining clocks is determined by the sampling frequency (f_S) by software or hardware control. SCKO2 and SCKO3 output 256 f_S and 384 f_S systems clocks, respectively. SCKO4 output is 768 f_S if the sampling frequency is 32kHz, 44.1kHz, 48kHz, or the output is 384 f_S if the sampling frequency is 64kHz, 88.2kHz, or 96kHz. Table I shows each sampling frequency. The system clock output frequencies are generated by a 27MHz master clock and programmed sampling frequencies are shown in Table II.

SAMPLING RATE		SAMPLING QUENCY	
Standard Sampling Frequencies	32	44.1	48
Double of Standard Sampling Frequencies	64	88.2	96

TABLE I. Sampling Frequencies.

SAMPLING FREQUENCY (kHz)	SAMPLING RATE	SKCO2 (MHz)	SCKO3 (MHz)	SCKO4 (MHz)
32	Standard	8.192	12.288	24.576
44.1	Standard	11.2896	16.9344	33.8688
48	Standard	12.288	18.4320	36.8640
64	Double	16.384	24.576	24.576
88.2	Double	22.5792	33.8688	33.8688
96	Double	24.576	36.8640	36.8640

TABLE II. Sampling Frequencies and Master Clock Output Frequencies.

Response time from power-on (or applying the clock to XT1) to SCKO settling time is typically 15ms. Delay time from sampling frequency change to SCKO settling time is 20ms maximum. Figure 4 illustrates SCKO transient timing.

External buffers are recommended on all output clocks in order to avoid degrading the jitter performance of the PLL1700.

RESET

The PLL1700 has an internal power-on reset circuit, as well as an external forced reset (RST, pin 18). Both resets have the same effect on the PLL1700 functions. The mode register default settings for software mode are initialized by reset. Throughout the reset period, all clock outputs are enabled with the default settings. Initialization for the internal power-on reset is done automatically during 1024 master clocks at $V_{DD} \geq 2.2V$ (1.8V to 2.6V). When using the internal power-on reset, RST should be HIGH. Power-on reset timing is shown in Figure 5. RST (pin 18) accepts an external forced reset by RST = L. Initialization (reset) is done when RST = L and 1024 master clocks after RST = H. External reset timing is shown in Figures 6 and 7.

FUNCTION CONTROL

The built-in function of the PLL1700 can be controlled in the software mode (serial mode), which uses a three-wire interface by ML (pin 1), MC (pin 20), and MD (pin 19), when MODE (pin 2) = L. They can also be controlled in the hardware mode (parallel mode) which uses SR0 (pin 1), FS1 (pin 20) and FS0 (pin 19), when MODE (pin 2) = H. The selectable functions are shown in Table III.

FUNCTION	HARDWARE MODE (MODE = H)	SOFTWARE MODE (MODE = L)
Sampling Frequency Select (32kHz, 44.1kHz, 48kHz)	Yes	Yes
Sampling Rate Select (Standard/Double)	Yes	Yes
Each Clock Output Enable/Disable	No	Yes

TABLE III. Selectable Functions.

HARDWARE MODE (MODE = H)

In the hardware mode, the following functions can be selected:

Sampling Group Select

The sampling frequency group can be selected by FS1 (pin 20) and FS0 (pin 19). This selection must be made with an interval time greater than $20\mu s$.

FS1 (Pin 20)	FS0 (Pin 19)	SAMPLING GROUP
L	L	48kHz
L	Н	44.1kHz
Н	L	32kHz
Н	Н	Reserved

Sampling Rate Select

The sampling rate can be selected by SR0 (pin 1).

SR0 (Pin 1)	SAMPLING RATE SELECT
L	Standard
Н	Double

SOFTWARE MODE (MODE = L)

The PLL1700 special function in software mode is shown in Table IV. These functions are controlled using ML, MC, and MD serial control signal.

FUNCTION	DEFAULT
Sampling Frequency Select (32kHz, 44.1kHz, 48kHz)	48kHz Group
Sampling Rate Select (Standard/Double)	Standard
Each Clock Output Enable/Disable	Enable

TABLE IV. Selectable Functions.



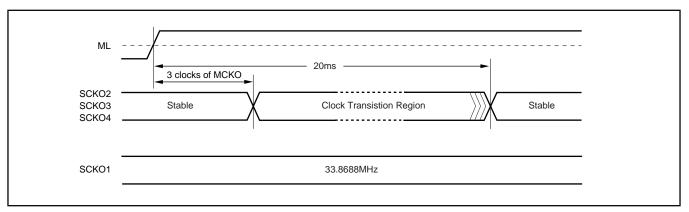


FIGURE 4. System Clock Transient Timing Chart.

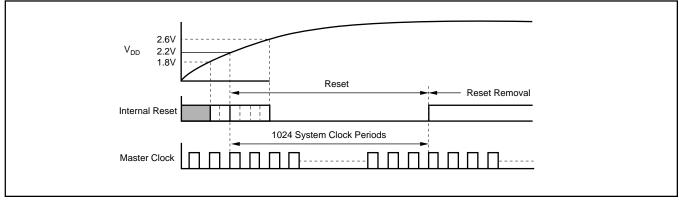


FIGURE 5. Power-On Reset Timing.

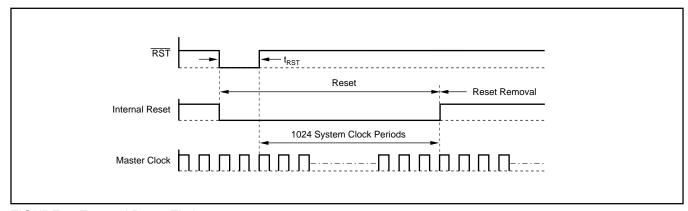


FIGURE 6. External Reset Timing.

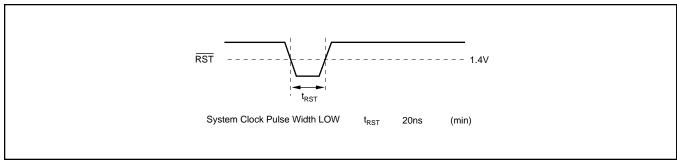


FIGURE 7. Reset Pulse Timing Requirement.





PROGRAM REGISTER BIT-MAPPING

The built-in functions of the PLL1700 are controlled through a 16-bit program register. This register is loaded using MD. After the 16 data bits are clocked in using the rising edge of MC, ML is used to latch the data into the register. Table V shows the bit-mapping of the registers. The software mode control format and control data input timing is shown in Figures 8 and 9, respectively.

Mode Register

							D8								
0	1	1	1	0	0	CE6	CE5	CE4	CE3	CE2	CE1	SR1	SR0	FS1	FS0

REGISTER	BIT NAME	DESCRIPTION
MODE	CE6	MCKO Output Enable/Disable
	CE5	MCKO Output Enable/Disable
	CE4	SCKO4 Output Enable/Disable
	CE3	SCKO3 Output Enable/Disable
	CE2	SCKO2 Output Enable/Disable
	CE1	SCKO1 Output Enable/Disable
	SR [1:0]	Sampling Rate Select
	FS [1:0]	Sampling Frequency Select

TABLE V. Register Mapping.

Mode Register

FS [1:0]: Sampling Frequency Group Select. This selection must be made with an interval time greater than 20μs.

FS1	FS0	SAMPLING FREQUENCY	DEFAULT
0	0	48kHz	0
0	1	44.1kHz	
1	0	32kHz	
1	1	Reserved	

SR [1:0]: Sample Rate Select

SR1	SR0	SAMPLING RATE	DEFAULT
0	0	Standard	0
0	1	Double	
1	0	Reserved	
1	1	Reserved	

CE [1:6]: Clock Output Control

CE1 - CE6	CE1 - CE6 CLOCK OUTPUT CONTROL			
0	Clock Output Disable			
1	Clock Output Enable	0		

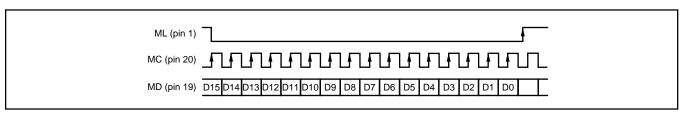


FIGURE 8. Software Mode Control Format.

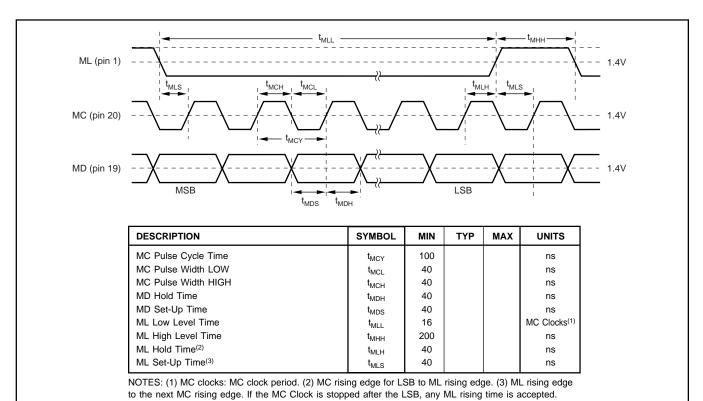


FIGURE 9. Control Data Input Timing.



CONNECTION DIAGRAM

Figure 10 shows the typical connection circuit for the PLL1700. There are three grounds for digital, analog and PLL power supply. However, the use of one common ground connection is recommended to avoid latch-up problems. Power supplies should be bypassed as close as possible to the device.

MPEG-2 APPLICATIONS

Typical applications for the PLL1700 are MPEG-2 based systems such as DVD players, DVD add-on cards for multimedia PCs, digital HDTV systems, and set-top boxes. The PLL1700 provides audio system clocks for a CD-DA DSP, DVD DSP, Karaoke DSP, and DAC(s) from a 27MHz video clock.

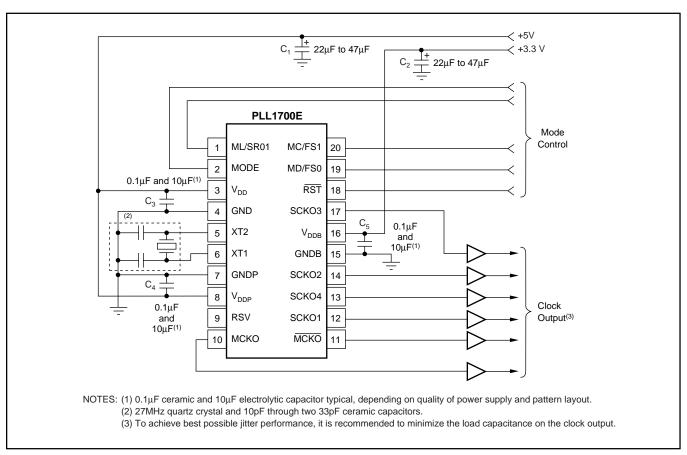


FIGURE 10. Typical Connection Diagram.

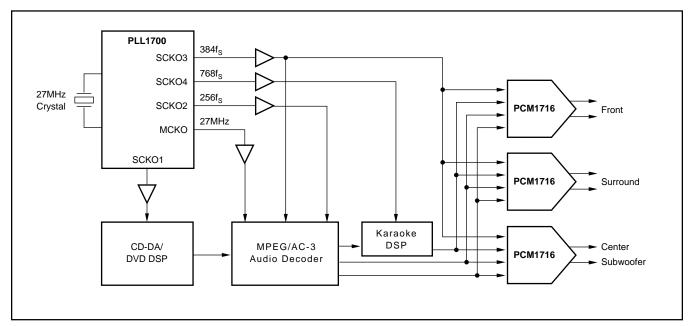


FIGURE 11. PLL1700 System Application Block Diagram.





Revision History

DATE	REVISION	PAGE	SECTION	DESCRIPTION				
		_	Entire Document	Updated format to current standard look.				
				Added note (1) to V _{IH} and V _{IL} .				
		3	Electrical Characteristics	Added two rows to Input Logic Level for $V_{\rm IH}$ and $V_{\rm IL}$ with note (2).				
				Added condition to <i>Clock Duty Cycle</i> row stating that $C_1 = C_2 = 15pF$.				
		5	Master Clock and	Changed "X2 should be connected" to "X2 must be connected."				
F/07	_	3	System Clock Output	Added text regarding signal amplitude.				
5/07	Α	5	Figure 5	Changed voltage from 2.0V to 1.2V.				
	Changed t _X			Changed voltage from 0.8V to 0.4V.				
				Changed t _{XT1H} min value from 15 to 10.				
		Added text regarding interval time.						
		8	Mode Register	Added text regarding interval time.				
		0	Figure 10	Deleted note (1) from C ₁ and C ₂ .				
		9	Figure 10	Changed note text from "tantalum" to "electrolytic" capacitor.				

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.



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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing		Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
PLL1700E	NRND	SSOP	DB	20	65	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		PLL1700E	
PLL1700E/2K	NRND	SSOP	DB	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		PLL1700E	
PLL1700E/2KG4	NRND	SSOP	DB	20	2000	TBD	Call TI	Call TI			
PLL1700EG	NRND	SSOP	DB	20	65	RoHS & Non-Green	SNBI	Level-1-260C-UNLIM		PLL1700EG	
PLL1700EG/2K	NRND	SSOP	DB	20	2000	RoHS & Non-Green	SNBI	Level-1-260C-UNLIM		PLL1700EG	
PLL1700EG4	NRND	SSOP	DB	20	65	TBD	Call TI	Call TI			

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	<u> </u>
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PLL1700E/2K	SSOP	DB	20	2000	330.0	17.4	8.5	7.6	2.4	12.0	16.0	Q1
PLL1700EG/2K	SSOP	DB	20	2000	330.0	17.4	8.5	7.6	2.4	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PLL1700E/2K	SSOP	DB	20	2000	336.6	336.6	28.6
PLL1700EG/2K	SSOP	DB	20	2000	336.6	336.6	28.6

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
PLL1700E	DB	SSOP	20	65	500	10.6	500	9.6
PLL1700EG	DB	SSOP	20	65	500	10.6	500	9.6
PLL1700EG4	DB	SSOP	20	65	500	10.6	500	9.6



SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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